

# **PRODUCT CHANGE NOTICE**

## **Package Orientation Change for Tray Packing of the Listed Intersil Products**

**Refer to:  
PCN12066**

**Date: August 8, 2012**

August 8, 2012

To: Our Valued Intersil Customers

Subject: **Package Orientation Change for Tray Packing of the Listed Intersil Products**

This notice is to inform you that Intersil is changing the package orientation for tray packing of the listed QFN (Quad Flat No-Lead) plastic packaged products. The change in package orientation aligns pin 1 of the device with the tray chamfer/notch and is in accordance with established industry standards for packing of IC products. Diagrams depicting the changes in package orientation are included on the next page for reference. There will be no change in the trays (i.e. dimensions, materials, appearance, etc.) used for product shipment.

Products affected:

**ISL8200MIRZ**

**ISL8201MIRZ**

**ISL8204MIRZ**

**ISL8206MIRZ**

Intersil will take all necessary actions to conform to agreed upon customer requirements and to ensure the continued high quality and reliability of Intersil products. Customers may expect to receive shipments of the listed products packed in trays using the new orientation beginning ninety days from the date of this notification.

If you have concerns with this notice, Intersil must hear from you promptly. Please contact the nearest Intersil Sales Office or call the Intersil Corporate line at 1-888-468-3774, in the United States, or 1-321-724-7143 outside of the United States.

Regards,



Jon Brewster  
Intersil Corporation

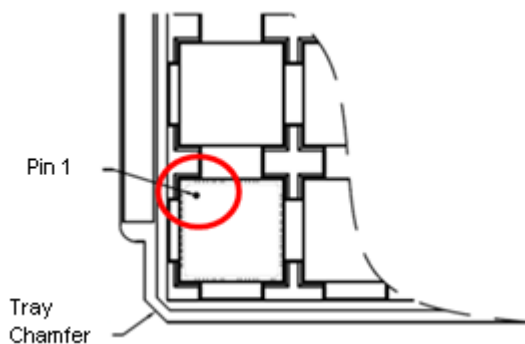
PCN12066

CC: J. McNamara C. Toh H. Li G. Parker N. Anantharajah

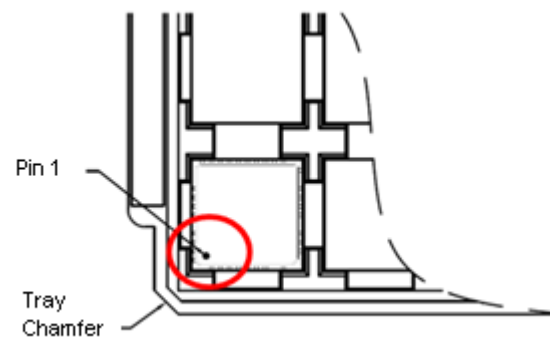
## Package Orientation Diagram - PCN12066

### Products ISL8200MIRZ

**From**

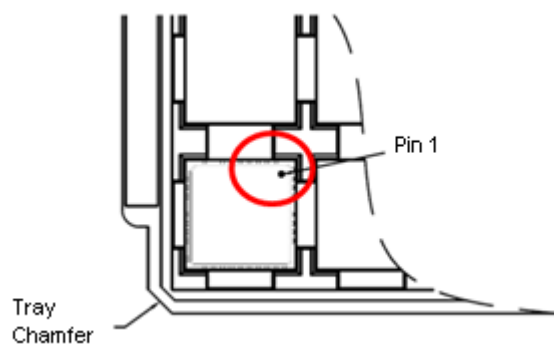


**To**



### Products ISL8201MIRZ, ISL8204MIRZ, and ISL8206MIRZ

**From**



**To**

